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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
10/063,887	05/21/2002	Chien-Chih Fu	AMIP0015USA	2364
27765	7590 06/20/2003			
NAIPO (NORTH AMERICA INTERNATIONAL PATENT OFFICE)			EXAMINER	
	.O. BOX 506 MERRIFIELD, VA 22116		PRENTY, MARK V	
•			ART UNIT	PAPER NUMBER
			2822	<u> </u>
			DATE MAILED: 06/20/2003)

Please find below and/or attached an Office communication concerning this application or proceeding.







Office Action Summary

Application No. 10/063,887

Examiner

Applicant(s)

Prenty

Art Unit 2822

FU

The MAILING DATE of this communication appears	on the cover sheet with the correspondence address
Period for Reply	
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET THE MAILING DATE OF THIS COMMUNICATION. Extensions of time may be available under the provisions of 37 CFR 1.136 (a). In	
mailing date of this communication. If the period for reply specified above is less than thirty (30) days, a reply within the lift NO period for reply is specified above, the maximum statutory period will apply a Failure to reply within the set or extended period for reply will, by statute, cause the large transfer of the later than three months after the mailing date of the earned patent term adjustment. See 37 CFR 1.704(b).	ne statutory minimum of thirty (30) days will be considered timely. and will expire SIX (6) MONTHS from the mailing date of this communication. ne application to become ABANDONED (35 U.S.C. § 133).
Status	
1) 🛛 Responsive to communication(s) filed on May 21, 2	2002
2a) ☐ This action is FINAL . 2b) ☒ This act	ion is non-final.
3) Since this application is in condition for allowance closed in accordance with the practice under Ex pa	except for formal matters, prosecution as to the merits is rte Quayle, 1935 C.D. 11; 453 O.G. 213.
Disposition of Claims	
4) 💢 Claim(s) <u>1-21</u>	is/are pending in the application.
4a) Of the above, claim(s)	is/are withdrawn from consideration.
5) Claim(s)	is/are allowed.
6) 💢 Claim(s) <u>1-4, 6-11, and 14-19</u>	is/are rejected.
7) 💢 Claim(s) <u>5, 12, 13, 20, and 21</u>	is/are objected to.
8) Claims	are subject to restriction and/or election requirement.
Application Papers	
9) \square The specification is objected to by the Examiner.	
10) The drawing(s) filed on is/are	a) \square accepted or b) \square objected to by the Examiner.
Applicant may not request that any objection to the d	rawing(s) be held in abeyance. See 37 CFR 1.85(a).
11) The proposed drawing correction filed on	is: a) \square approved b) \square disapproved by the Examiner.
If approved, corrected drawings are required in reply	to this Office action.
12) \square The oath or declaration is objected to by the Exam	ner.
Priority under 35 U.S.C. §§ 119 and 120	
13) 🗓 Acknowledgement is made of a claim for foreign p	riority under 35 U.S.C. § 119(a)-(d) or (f).
a) ☑ All b) ☐ Some* c) ☐ None of:	
1. X Certified copies of the priority documents hav	e been received.
2. Certified copies of the priority documents have	e been received in Application No
application from the International Bure	
*See the attached detailed Office action for a list of th	·
14) Acknowledgement is made of a claim for domestic	
a) U The translation of the foreign language provisiona	
15) ☐ Acknowledgement is made of a claim for domestic	priority under 35 U.S.C. 33 120 and/or 121.
Attachment(s) 1) X Notice of References Cited (PTO-892)	4) Interview Summary (PTO-413) Paper No(s).
2) Notice of Draftsperson's Patent Drawing Review (PTO-948)	5) Notice of Informal Patent Application (PTO-152)
3) Information Disclosure Statement(s) (PTO-1449) Paper No(s).	6) Other:

This Office Action is in response to the papers filed May 21, 2002.

Claims 1-4, 6, 7, 9-11 and 14-19 are rejected under 35 U.S.C. §102(e) as being anticipated by Ishimura et al. (United States Patent 6,329,700, hereafter Ishimura).

With respect to independent claim 1, Ishimura discloses scribe lines for increasing a utilizable area on a wafer, the wafer comprising a plurality of dies, the scribe lines comprising (see the entire patent, including Fig. 2, for example): at least a first scribe line DXb arranged in a first direction in a first gap of the dies CR1, the first scribe line DXb having a first width Lb; and at least a second scribe line DXa arranged in the first direction in a second gap of the dies, the second scribe line DXa having a second width La narrower than the first width.

Claim 1 is thus rejected under 35 U.S.C. §102(e) as being anticipated by Ishimura.

With respect to dependent claim 2, Ishimura's first scribe line DXb comprises at least an alignment mark SM1 for aligning elements on different dies.

Claim 2 is thus rejected under 35 U.S.C. §102(e) as being anticipated by Ishimura.

With respect to dependent claim 3, Ishimura's first scribe line DXb comprises at least a test key TP for performing a quality test on the dies.

Claim 3 is thus rejected under 35 U.S.C. §102(e) as being anticipated by Ishimura.

With respect to dependent claim 4, Ishimura's first width Lb is approximately between 100 and 500 micrometers (see column 5, lines 10-13, for example).

Claim 4 is thus rejected under 35 U.S.C. §102(e) as being anticipated by Ishimura.

With respect to dependent claim 6, Ishimura's second scribe line DXa is provided for dicing the wafer (see the Abstract, for example).

Claim 6 is thus rejected under 35 U.S.C. §102(e) as being anticipated by Ishimura.

With respect to dependent claim 7, Ishimura's wafer is scribed by supplying a mechanical stress on the scribe lines (see column 4, lines 61-64, for example).

Claim 7 is thus rejected under 35 U.S.C. §102(e) as being anticipated by Ishimura.

With respect to dependent claim 9, Ishimura's wafer further comprises a plurality of scribe lines DYa and DYb arranged in a second direction, the scribe lines arranged in the second direction and comprising various scribe line widths La and Lb.

Claim 9 is thus rejected under 35 U.S.C. §102(e) as being anticipated by Ishimura.

With respect to dependent claim 10, Ishimura's second direction is perpendicular to the first direction.

Claim 10 is thus rejected under 35 U.S.C. §102(e) as being anticipated by Ishimura.

With respect to dependent claim 11, Ishimura's dies CR1 are in the same shapes and sizes.

Claim 11 is thus rejected under 35 U.S.C. §102(e) as being anticipated by Ishimura.

With respect to independent claim 14, Ishimura discloses scribe lines on a wafer, the wafer comprising a plurality of dies, the scribe lines comprising (see the entire patent, including Fig. 2, for example): a plurality of first scribe lines DXb

positioned in gaps of the dies, each of the first scribe lines comprising a predetermined pattern; and a plurality of second scribe lines DXa positioned in gaps of the dies, the second scribe lines being narrower than the first scribe lines.

Claim 14 is thus rejected under 35 U.S.C. §102(e) as being anticipated by Ishimura.

With respect to dependent claim 15, Ishimura's predetermined pattern DXb comprises an alignment mark SM1 for aligning elements on different dies.

Claim 15 is thus rejected under 35 U.S.C. §102(e) as being anticipated by Ishimura.

With respect to dependent claim 16, Ishimura's predetermined pattern DXb comprises a test key TP for performing a quality test on the dies.

Claim 16 is thus rejected under 35 U.S.C. §102(e) as being anticipated by Ishimura.

With respect to dependent claim 17, Ishimura's first scribe lines DXb comprise at least an arranging direction.

Claim 17 is thus rejected under 35 U.S.C. §102(e) as being anticipated by Ishimura.

With respect to dependent claim 18, Ishimura's second scribe lines DXa comprise at least an arranging direction.

Claim 18 is thus rejected under 35 U.S.C. §102(e) as being anticipated by Ishimura.

With respect to dependent claim 19, Ishimura's dies CR1 are in the same shapes and sizes.

Claim 19 is thus rejected under 35 U.S.C. §102(e) as being anticipated by

Ishimura.

Claim 8 is rejected under 35 U.S.C. §103(a) as being unpatentable over Ishimura et al. (United States Patent 6,329,700 - hereafter Ishimura) together with Yung et al. (United States Patent 6,075,280 - hereafter Yung).

The difference between Ishimura's scribe lines (see the rejection of independent claim 1 above) and dependent claim 8's scribe lines is they are sawed and etched, respectively.

Yung teaches it is advantageous to etch scribe lines rather than saw them (see the entire patent).

It would have been obvious to one skilled in this art to advantageously etch Ishimura's scribe lines rather than saw them, as per Yung's teaching.

Claim 8 is thus rejected under 35 U.S.C. 103(a) as being unpatentable over Ishimura together with Yung.

Claim 5 is objected to as being dependent on a rejected base claim (i.e., claim 5 would be allowable over the prior art of record if amended to further include all the limitations of independent claim 1).

Claim 12 is objected to as being dependent on a rejected base claim (i.e., claim 12 would be allowable over the prior art of record if amended to further include all the limitations of independent claim 1).

Claim 13 is objected to as being dependent on a rejected base claim (i.e., claim 13 would be allowable over the prior art of record if amended to further include all the limitations of independent claim 1).

Claim 20 is objected to as being dependent on a rejected base claim (i.e., claim 20 would be allowable over the prior art of record if amended to further include all the

Mark Prenty Merk V. Prenty Primary Exeminat

limitations of independent claim 1).

Claim 21 is objected to as being dependent on a rejected base claim (i.e., claim 21 would be allowable over the prior art of record if amended to further include all the limitations of independent claim 1).

Registered practitioners can telephone examiner Prenty at (703) 308-4939. Any voicemail message left for the examiner must include the name and registration number of the registered practitioner calling, and the application's Serial Number. Technology Center 2800's general telephone number is (703) 308-0956.